

EDT 5.7" TFT VGA With Touch V1.0a







Revision History

Date	Doc. Rev.	EDT 5.7" TFT VGA with Touch Version	Changes
12-Mar-12	Rev. 1.0	V1.0a	Preliminary Release
17-Aug-17	Rev. 1.1	V1.0a	Removed document meta-data



EXAMINED BY:		FILE NO . CAS-0006970
Vincent Wh	EMERGING DISPLAY	ISSUE : SEP.30, 2009
APPROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 29
David Chang		VERSION: 2
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
CUSTOMER'S APPROV	DEL NO.: ET057090DHU (RoHS) MESSRS:	
DATE :		
BY:		



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				DOC. FIRST ISSUE		
RECORD			VISION			SEP.22, 2009
DATE	REVISE PAGE	-50		SUMMARY		
GED 20, 2000	NO.		4 DIEGEDIGAL	THA DA CENTRALEMACE		
SEP.30, 2009	3			CHARACTERISTICS Y VOLTAGE FOR VCOM DRIVER→	i	
				Y VOLTAGE FOR VCOM + LED DRI		
				Y CURRENT FOR VCOM DRIVER→ Y CURRENT FOR VCOM+LED DRI		
	5		ADD 5.3 DCLK A	ND DATA INPUT WAVEFORMS.		
	9	8	BLOCK DIAGR LED BACKLIG	AM HT → TOUCH PANEL		
	11,12	1	10. INTERFACE S	IGNALS		
	13	1	NO.30~32:ADI	D SYNC AND DE MODE SETTING PLY FOR LCM		
	15			UM 1KHz FREQUENCY		



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1. GENERAL SPECIFICATIONS

(12) INTERFACE MODE

1.1 APPLICATION NOTES FOR CONTROLLER/DRIVER PLEASE REFER TO :

HIMAX HX8250 HIMAX HX8678

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE)

2.	MECHANICAL SPECIFICATIONS (1) DIAGONALS	5.7 inch
	(2) NUMBER OF DOTS	640W * (RGB) * 480H DOTS
	(3) MODULE SIZE	124.7W * 100H *11.7D (MAX.) mm
		(WITHOUT FPC)
	(4) EFFECTIVE AREA	117.2W * 88.4H mm (T/P)
	(5) ACTIVE AREA	116.2W * 87.4H mm (T/P)
		115.2W * 86.4H mm (LCD)
	(6) DOT SIZE	0.06W * 0.18H mm
	(7) PIXEL SIZE	0.18W * 0.18H mm
	(8) LCD TYPE	TFT , TRANSMISSIVE
	(9) COLOR	262K
	(10) VIEWING DIRECTION	12 O'CLOCK

(11) BACK LIGHT LED, COLOR: WHITE

----- RGB 18 BIT PARALLEL (DE/SYNC MODE)



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3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY	VDD-VSS	-0.3	7.0	V	
VOLTAGE	VCC-VSS	-0.3	7.0	V	
INPUT SIGNAL VOLTAGE	VIN-VSS	- 0.3	VDD+0.3	V	
STATIC ELECTRICITY	_	_	_	V	NOTE(1)
LED BACKLIGHT POWER DISSIPATION	PD	<u></u>	1.92	W	
LED BACKLIGHT FORWARD CURRENT	IF		60	mA	
LED BACKLIGHT REVERSE VOLTAGE	VR	-	45	V	
VOLTAGE					

NOTE (1): LCM SHOULD BE GROUND DURING HANDING LCM.

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STORAGE		REMARK	
I I E M	MIN.	MAX.	MAX. MIN. MAX.		KEWAKK	
AMBIENT TEMPERATURE	-10 °C	60°C	- 20°C	70°C	NOTE(1),(2)	
HUMIDITY	NOTI	NOTE(3)		Ξ(3)	WITHOUT	
	NOTE (3)		11011	3(3)	CONDENSATION	
VIBRATION		2.45 m/s^2		11.76 m/s^2	10~55Hz	
VIBRATION		(0.25 G)	-	(1.2 G)	X, Y, Z, EACH 2HRS	
					6 m SECONDS	
SHOCK		29.4 m/s^2		490 m/s^2	XYZ	
SHOCK	_	(3G)	-	(50G)	DIRECTIONS	
				100	3 TIMES EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACCEPTABLE			

NOTE (1): Ta AT -20°C: 48HRS MAX.

70°C: 168HRS MAX

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE

THIS PHENOMENON IS REVERSIBLE. NOTE (3): Ta ≤ 60°C: 90%RH MAX (96HRS MAX).

Ta > 60°C: ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY

OF 90%RH AT 60°C(96HRS MAX).



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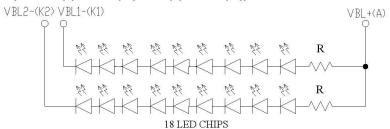
ELECTRICAL CHARACTERISTICS

 $Ta = 25 \, ^{\circ}C$

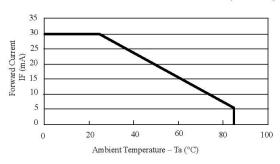
							1a - 25 °C
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE FOR DIGITAL	VDD-VSS	_	3	3.3	3.6	V	4
POWER SUPPLY VOLTAGE FOR VCOM+LED DRIVER	VCC-VSS	_	3	3.3	3.6	V	
LOW LEVEL INPUT VOLTAGE	VIL	_	0	_	0.3*VDD	V	NOTE (1)
HIGH LEVEL INPUT VOLTAGE	VIH	_	0.7*VDD	_	VDD	V	NOIE (I)
POWER SUPPLY CURRENT FOR DIGITAL	IDD	VDD-VSS =3.3V		(8)	(12)	mA	
POWER SUPPLY CURRENT FOR VCOM+LED DRIVER	ICC	VCC-VSS = 3.3V LED B/L=ON		550	710	mA	NOTE (2)
FRAME FREQUENCY	fFRAME	_	50	60	72	Hz	
DIMMING CONTROL FOR	LEDCTRL-VSS	_	0	_	3	V	NOTE (3)
LED BACKLIGHT	PWM	1KHz		3.3	_	V	NOTE (3)
LED CHIP LIFE TIME	-	_	30000	40000		HRS	

NOTE (1) : APPLIED TO TERMINALS /RESET,B5~B0,G5~G0,R5~R0,DCLK,HSYNC,VSYNC,ENB,ROTATE. NOTE (2) : THE DISPLAY PATTERN IS ALL "WHITE". NOTE (3) : INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT.

(VF=VBL+(A) - VBL1-(K1)=VBL+(A) - VBL2-(K2))



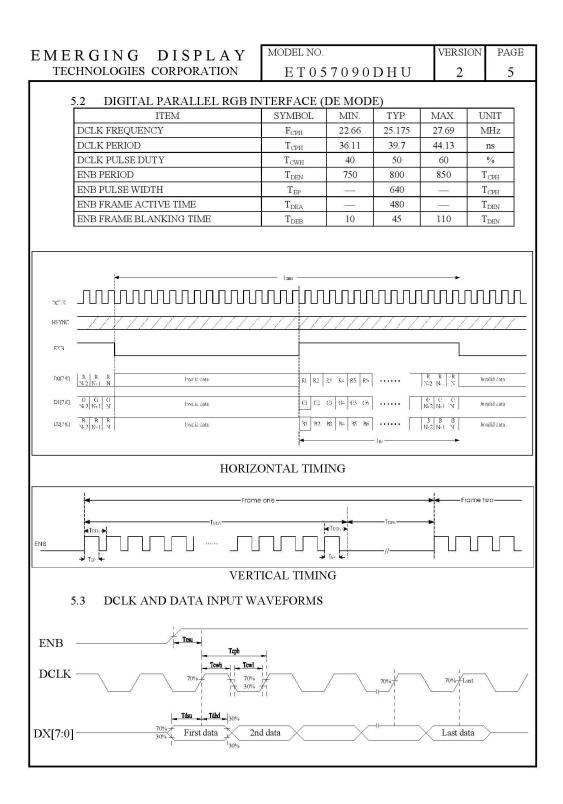
NOTE (4): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT. (PER LED)





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5 . TIMING CHARACTERISTICS 5.1 DIGITAL PARALLEL RGE	3 INTERFACE	(SYNC M	ODE)							
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT					
DCLK FREQUENCY	F_{CPH}	22.66	25.175	27.69	MHz					
DCLK PERIOD	T_{CPH}	36.11	39.7	44.13	ns					
DCLK PULSE DUTY	$T_{\rm CWH}$	40	50	60	%					
HSYNC PERIOD	T_{H}	750	800	850	T_{CPH}					
HSYNC PULSE WIDTH	$T_{ m WH}$	5	30	-	T_{CPH}					
HSYNC FIRST HORIZONTAL DATA TI		112	144	175	T_{CPH}					
HORIZONTAL ACTIVE DATA AREA	$T_{\rm HA}$	=	640	-	T_{CPH}					
VSYNC PULSE WIDTH	T _{WV}	1	3	5	T _H					
FIRST LINE DATA INPUT TIME	T _{STV}	-	35		T _H					
VSYNC PERIOD	T_{V}	515	525	535	T_{H}					
D. [7:5]	5-35 grape com 5500 Action 3	3		tavald tavald	dala					
	IZONTAL TIN		Ħ							
VSYNC Twv	Tv			, T	=					
HSYNC										







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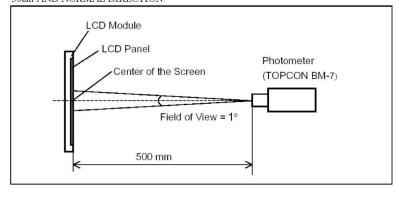
6. OPTICAL CHARACTERISTICS (NOTE 1) 6.1 OPTICAL CHARACTERISTICS

 $Ta = 25 \pm 2$ °C

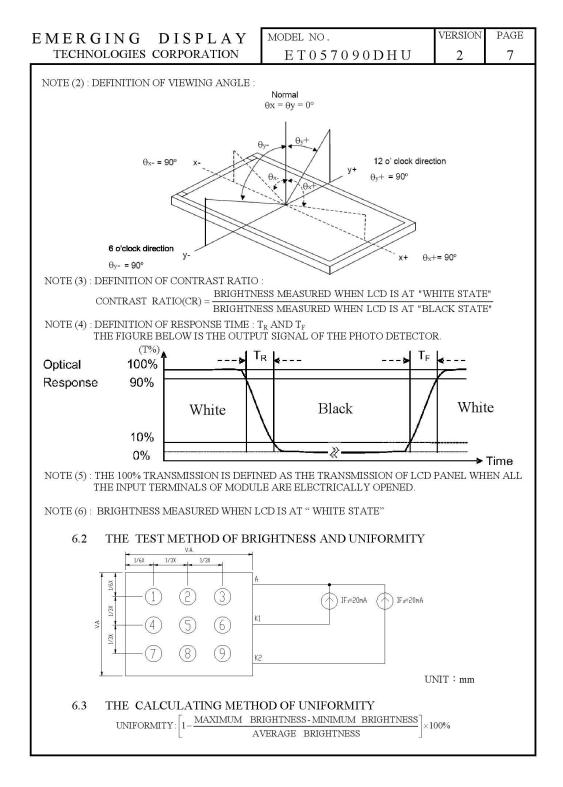
ITE	M	SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK
		θ_{y^+}		θ _x =0°	50	55			
VIEWING ANGL	Б	Θ_{y}	CR ≥ 10	O _x =0	47	52		deg.	NOTE (2)
VIEWING ANGE	.L	θ_{x^+}	CR ≥ 10	θ _v =0°	60	65		ucg.	NOTE (3)
		θ_{x}		O _y -O	60	65			
CONTRAST RATIO		CR	θx=0°,	θу=0°	300	350	_	-	NOTE (3)
RESPONSE TIME		T _R (rise)	000	009	-	15	30		NOTE (4)
RESPONSE HIM	3	T _F (fall)	θx=0°,	6y-0°		35	50	msec	NOIE (4)
	WHITE	Wx			0.26	0.31	0.36		
		Wy			0.30	0.35	0.40		
COLOD OF	RED	Rx	= IF = 4	θx=0°, θy=0° IF = 40mA NTSC: 50 %	0.56	0.61	0.66	-	NOTE (5)
COLOR OF	KED	Ry			0.31	0.36	0.41		
CIE COORDINATE	CDEEN	Gx			0.28	0.33	0.38		1
COOKDINATE	GREEN	Gy			0.51	0.56	0.61	8 	
	BLUE	Bx			0.09	0.14	0.19		
	BLUE	Ву			0.07	0.12	0.17	1511	
THE BRIGHTNE	SS	В			250	400		- 1/ 2	
OF MODULE		В	θx=0°,	θy=0°	350	400	·	cd/m ²	NOTE (6)
THE UNIFORMIT MODULE	ГҮ ОБ	-	IF = 2	10mA	75	80	_	%	NOTE (6)

NOTE (1): TEST EQUIPMENT SETUP:

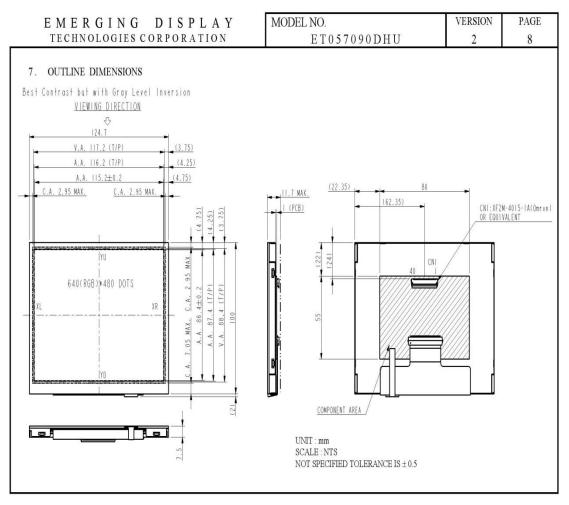
AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



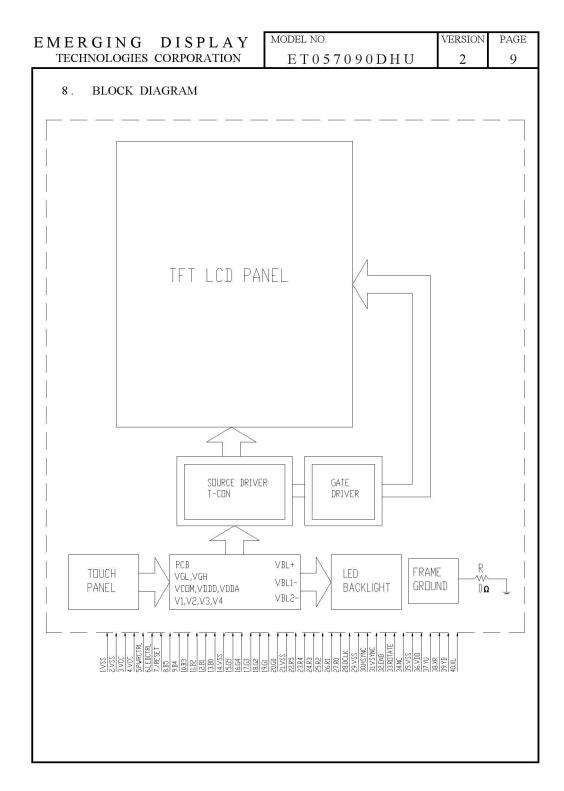




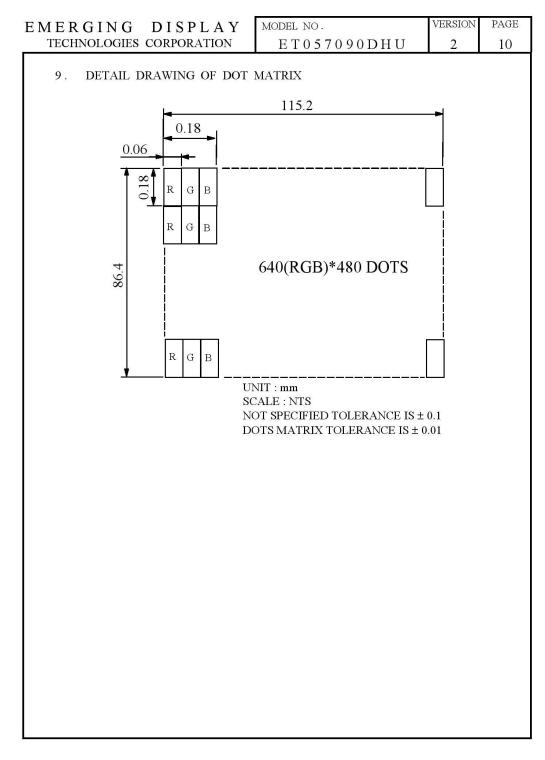














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10. INTERFACE SIGNALS

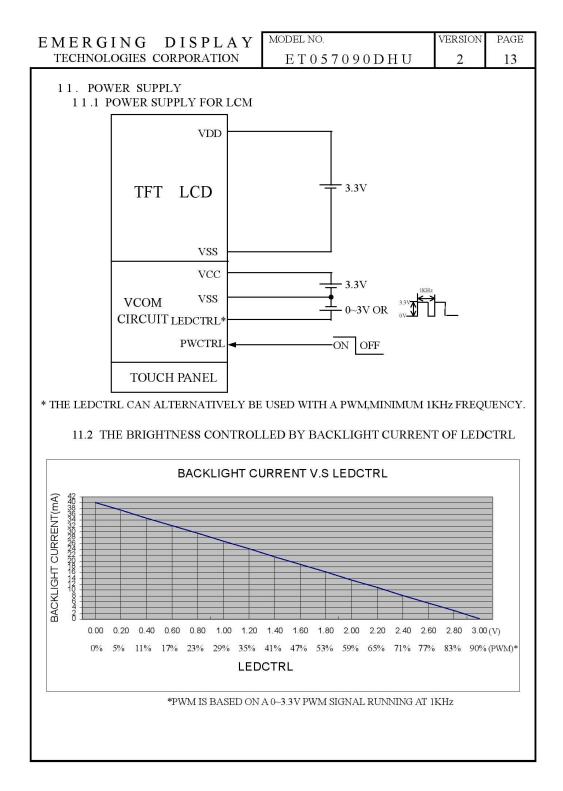
PIN NO	SYMBOL	I/O		FUNCTION			
1	VSS	P	GROUND (VSS IS CON	NECTED TO METAL HO	OUSING WITH		
2	VSS	P	CONDUCTIVE TAPE)				
3	VCC	P	POWER SUPPLY FOR	VCOM DRIVER CIRCUI	Γ		
4	VCC	P	POWER SUPPLY FOR	VCOM DRIVER CIRCUI	Γ		
			LOGIC	PWCTRL REMARK			
5	PWCTRL	I	LEVEL	Н	POWER ON		
			H=3.3V L=0V	L	SHUTDOWN		
6	LEDCTRL	I	BRIGHTNESS CONTRO POWER SUPPLY 0~3V	OL FOR LED BACKLIGH OR PWM SIGNAL	IT:		
7	/RESET	I	HARDWARE RESET				
8	В5	I	BLUE DATA BIT 5	ELUE DATA BIT 5			
9	В4	I	BLUE DATA BIT 4				
10	В3	I	BLUE DATA BIT 3		â		
11	B2	I	BLUE DATA BIT 2	BLUE DATA BIT 2			
12	B1	I	BLUE DATA BIT 1				
13	В0	I	BLUE DATA BIT 0				
14	VSS	P	GROUND (VSS IS CON CONDUCTIVE TAPE)	INECTED TO METAL HO	OUSING WITH		
15	G5	1	GREEN DATA BIT 5				
16	G4	Ι	GREEN DATA BIT 4				
17	G3	Ι	GREEN DATA BIT 3				
18	G2	I	GREEN DATA BIT 2				
19	G1	I	GREEN DATA BIT 1				
20	G0	Ι	GREEN DATA BIT 0				
21	VSS	P	GROUND (VSS IS CON CONDUCTIVE TAPE)	INECTED TO METAL HO	OUSING WITH		
22	R5	Ι	RED DATA BIT 5				
23	R4	Ι	RED DATA BIT 4				
24	R3	I	RED DATA BIT 3				
25	R2	I	RED DATA BIT 2				
26	R1	I	RED DATA BIT 1				
27	R0	I	RED DATA BIT 0				
28	DCLK	Ί	DOT DATA CLOCK				
29	VSS	P	GROUND (VSS IS CON CONDUCTIVE TAPE)	NECTED TO METAL HO	OUSING WITH		



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PIN NO	SYMBOL	I/O	FUN	CTION		
30	HSYNC	I	HORIZONTAL SYNC INPUT	DE & SYNC MODE SETTING DE MODE : ONLY ENB AND		
31	VSYNC	Ι	VERTICAL SYNC INPUT	PIXEL CLOCK IS NECESSARY. SYNC MODE : ENB SHOULD BE CONNECTED TO VSS.		
32	ENB	Ι	DATA ENABLE INPUT	HSYNC/VSYNC AND PIXEL CLOCK IS NECESSARY.		
33	ROTATE	I	WHEN ROTATE="H" THEN UD="H" LEVEL : OUT1→480 LR="L" LEVEL : OUT960→1 WHEN ROTATE="L" THEN UD="L" LEVEL : OUT480→1 (DE LR="H" LEVEL : OUT1→960 (DE)	*		
34	NC	-	NON CONNECTION			
35	VSS	P	GROUND (VSS IS CONNECTED T CONDUCTIVE TAPE)	TO METAL HOUSING WITH		
36	VDD	P	POWER SUPPLY FOR DIGITAL C	IRCUIT		
37	YU		TOP PANEL			
38	XR	-	RIGHT PANEL	TOUCH PANEL		
39	YD	-	BOTTOM PANEL	TOUCH PANEL		
40	XL	_	LEFT PANEL			







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12. TOUCH PANEL SPECIFICATION 12.1 ELECTRICAL CHARACTERISTICS

Ta =25°C

ITEM	CONDITION	SPEC.	UNIT
LINEARITY	_	≤ 1.5	%
TRANSMISSION	ASTM D1003	80 OR MORE	%
ON LOAD	POLYACETAL PEN INPUT	15 ~ 80	g
TERMINAL RESISTANCE	X AXIS	$400 \sim 1000$	Ω
TERMINAL RESISTANCE	Y AXIS	$200\sim700$	5.2
INSULATION RESISTANCE	DC25V	≥ 10	$M\Omega$
INPUT VOLTAGE		5	V

12.2 PRECAUTIONS IN USE OF TOUCH PANEL

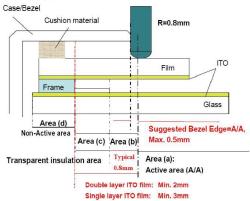
12.2.1 PURPOSE:

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

12.2.2 ITEM AND ILLUSTRATION:

(1) STRUCTURE, AREA DEFINITION

THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA OF THIS TOUCH PANEL ARE DEFINED BELOW :



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL. IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.

ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT

UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET $\,$

CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.



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AREA(a): ACTIVE AREA

THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b): OPERATION NON-GUARANTEED AREA

THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION AND ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL SHOWS DEGRADATION OF ITS PERFORMANCE AND DURABILITY SUCH AS A PEN SLIDING DURABILITY BECOMES ABOUT ONE-TENTH COMPARED WITH THE ACTIVE AREA (AREA-(A) AS GUARANTEED AREA) AND ITS OPERATION FORCE REQUIRES ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE FROM A BOUNDARY OF THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c): PRESSING PROHIBITION AREA

THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE LOAD IS
APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A SERIOUS DAMAGE

IS GIVEN TO A TOUCH PANEL FUNCTION BY PRESSING.

AREA(d): NON-ACTIVE AREA
THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.

- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING
 - (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.
 - (ii) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC (FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.
- (iii) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3MM BETWEEN THE PRODUCT AND DISPLAY.
- (iv) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY (REFER TO ITEM 5.1.2. STRUCTURE, AREA DEFINITION).

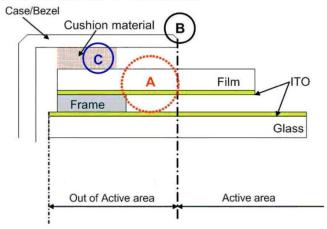
BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED OUTSIDE OF THE ACTIVE AREA, IT MAY CAUSE THE DAMAGE OF THE ITO FILM.



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(v) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME.



- (vi) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION.
- (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL.
- (viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP. WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL.
- (ix) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET.
- (3) CAUTIONS FOR OPERATION
 - (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHO'S TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.



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- (ii) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.
- (iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THI NG OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

12.3 DURABILITY

12.3.1 STYLUS HITTING:

ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN: R8 mm SILICON RUBBER

LOAD: 250g

FREQUENCY: 240 times/min
MEASUREMENT POSITION:
1 POINT OF TOUCH PANEL ACTIVE AREA

REPEATED: OVER 1,000,000 TIMES

12.3.2 PEN TOUCH SLIDING DURABILITY:

100,000 TIMES OR OVER

WRITING WITH RO.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g

IN ACTIVE AREA. SPEED IS 60mm/sec.

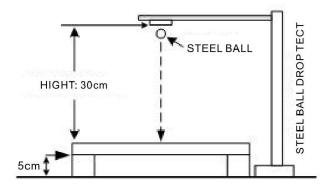


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12.4 STEEL BALL DROP TEST

BY USING F9mm STEEL BALL FROM THE HEIGHT OF 30cm AND FALLING ON TOUCH PANEL SURFACE, MUST PASS BELOW CONDITIONS: APPEARANCE: THE APPEARANCE WITHOUT ANY CHANGE, INCLUDING THE PANEL BROKEN.



12.5 APPEARANCE INSPECTION

PURPOSE:

TO ESTABLISH APPEARANCE STANDARD AND MAINTAIN PRODUCT QUALITY \circ

SCOPE:

TOUCH PANEL VIEW AREA WITHIN TOUCH PANEL •

12.5.1 RULE:

INSPECTION CONDITION

- (A) ENVIRONMENTAL LUMINANCE: 500 LUX °
- (B) DISTANCE BETWEEN HUMAN EYES AND PANEL: 30cm (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT) °
- (C) VISUAL ANGEL : $> 60^{\circ}$
- (D) LIGHT SOURCE: FLUORESCENT LIGHT SOURCE •
- 12.5.2 JUDGE CRITERION:

JUDGEMENT UNDER ABOVE MENTIONED CRITERION (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT),

TESTING GOODS DEFECT CAN BE VISIBLE WITHIN 10 SECONDS, WHICH WILL BE JUDGED AS MAJOR DEFECTS \circ

SAMPLING STANDARD:

THE SAMPLING STANDARD WILL BE CONFIRMED BY BOTH OF EDT AND CUSTOMER.



TECHNOLOGIES CORPORATION E T 0 5 7 0 9 0 D H U 2 19 INSPECTION ITEMS SEPC. JUDGE CRITERION OPERATION GUIDELINE W \leq 0.05mm & L \leq 10mm ACCEPTABLE W $>$ 0.05mm & L \leq 5mm NOT ACCEPTABLE DBJECT W \leq 0.05mm & L \leq 5mm ACCEPTABLE D \leq 0.25mm ACCEPTABLE D \leq 0.25mm ACCEPTABLE D \leq 0.25mm ACCEPTABLE D \leq 0.25mm ACCEPTABLE D \leq 0.30mm NOT ACCEPTABLE D \leq 0.30mm NOT ACCEPTABLE D \leq 0.5mm ACCEPTABLE D \leq 0.5mm ACCEPTABLE D \leq 0.5mm NOT ACCEPTABLE D \leq 0.5mm ACCEPTABLE	MERGING	DIS	PLAY	MODEL NO.		VERSION	PAGE
$ \begin{array}{c} \text{CCRATCH} & \text{W} \leq 0.05 \text{mm} \& \text{L} \leq 10 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 10 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} \text{ or L} \geq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} & \text{L} \leq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 5 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{MAX}. 2 \text{ EA} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.5 \text{mm} & \text{ACCEPTABLE} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{Y} \leq 3 \text{mm} \\ \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{Y} \leq 3 \text{mm} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{ACCEPTABLE} \\ \text{EDGF} & \text{W} \leq 3 \text{mm} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ Chip $				ET05709	0 D H U	2	19
$ \begin{array}{c} \text{CCRATCH} & \text{W} \leq 0.05 \text{mm} \& \text{L} \leq 10 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 10 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} \text{ or L} \geq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} & \text{L} \leq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 5 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{MAX}. 2 \text{ EA} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.5 \text{mm} & \text{ACCEPTABLE} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{Y} \leq 3 \text{mm} \\ \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{Y} \leq 3 \text{mm} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{ACCEPTABLE} \\ \text{EDGF} & \text{W} \leq 3 \text{mm} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ Chip $							
$ \begin{array}{c} \text{CCRATCH} & \text{W} \leq 0.05 \text{mm} \& \text{L} \leq 10 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 10 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} \text{ or L} \geq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} \geq 0.05 \text{mm} & \text{L} \leq 5 \text{mm} & \text{ACCEPTABLE} \\ \text{W} > 0.05 \text{mm} \text{ or L} > 5 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} \leq 0.25 \text{mm} & \text{ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{MAX}. 2 \text{ EA} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.30 \text{mm} & \text{NOT ACCEPTABLE} \\ \text{D} > 0.5 \text{mm} & \text{ACCEPTABLE} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{Y} \leq 3 \text{mm} \\ \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{Y} \leq 3 \text{mm} \\ \text{CORNER} & \text{X} \leq 3 \text{mm} \\ \text{CORNER} & \text{ACCEPTABLE} \\ \text{EDGF} & \text{W} \leq 3 \text{mm} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{ACCEPTABLE} \\ \text{Chip of glass} \\ Chip $	INSPECTION ITEMS	Γ	SEDC	THINGE CRITERION	OPERATI(ON GUIDEL	INE
SCRATCH $W > 0.05 mm$ or $L > 10 mm$ NOT ACCEPTABLE $W \le 0.05 mm$ & $L \le 5 mm$ ACCEPTABLE $W > 0.05 mm$ or $L > 5 mm$ NOT ACCEPTABLE $W > 0.05 mm$ NOT ACCEPTABLE $W > 0.05 mm$ NOT ACCEPTABLE $W > 0.05 mm$ NOT ACCEPTABLE $W > 0.05 mm$ ACCEPTABLE $W > 0.05 mm$ NOT ACCEPTABLE $W > 0.05 mm$ ACCEPTA				The second of th	E		IIVE
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	SCRATCH					0.	
DBJECT $W > 0.05 mm$ or $L > 5 mm$ NOT ACCEPTABLE $D \le 0.25 mm$ ACCEPTABLE $D \le 0.25 mm$ ACCEPTABLE $CORNEIGN$ DBJECT $D > 0.30 mm$ MAX. 2 EA $CORNER$ DSJECT $D > 0.30 mm$ NOT ACCEPTABLE $CORNEIGN$ DSJECT $CORNER$ COR	LINEAR FOREIGN	TECHNOLOGY STONE SECTION SECTIONS SECTION SECT			TESTING C	FLUORESCENT L	JIGHT SOURCE
GRANULAR FOREIGN DBJECT $D > 0.30 \text{mm} \qquad \text{NOT ACCEPTABLE}$ $D > 0.5 \text{mm} \qquad \text{NOT ACCEPTABLE}$ $D > 0.5 \text{mm} \qquad \text{ACCEPTABLE}$ $D > 0.5 \text{mm} \qquad \text{NOT ACCEPTABLE}$	OBJECT	W > 0.05	mm or L >5mm	NOT ACCEPTABLE		300mm	= >
GRANULAR COREIGN O.25mm $<$ D \le 0.30mm MAX. 2 EA D $=$ TESTING GOODS ODES DEFINITION OF THE STING GOODS O		D	≤ 0.25mm	ACCEPTABLE			MINANCE : 500L
D \leq 0.5mm ACCEPTABLE D \leq 0.5mm NOT ACCEPTABLE D > 0.5mm NOT ACCEPTABLE Chip of glass CORNER $Y \leq 3mm \cdot Z < t$ $(t = /thickness)$ ACCEPTABLE EDGE $W \leq 3mm \cdot X = T$	GRANULAR FOREIGN OBJECT	0.25mm	ı < D ≤0.30mm	MAX. 2 EA	FLUORESCENT LIGHT SOURCE	E STING GOODS	= -
PET BUBBLES $D>0.5mm$ NOT ACCEPTABLE $D>0.5mm$ NOT ACCEPTABLE $D>0.5mm$ Chip of glass $D>0.5mm$ CORNER $D>0.5mm$ Chip of glass $D>0.5mm$ Chip of glas		D	>0.30mm	NOT ACCEPTABLE	600	ENVIRONMENTAL IUW	@NANCE : 500L
D>0.5mm NOT ACCEPTABLE D Chip of glass CHIP ON GLASS $X \le 3mm \cdot X \le t$ $(t = /thickness)$ ACCEPTABLE $X \le 3mm \cdot X \le t$ $(t = /thickness)$ ACCEPTABLE $X \le 3mm \cdot X \le t$ $(t = /thickness)$	DET DITRRI ES	D	≤0.5mm	ACCEPTABLE	D	٠	TO 1
CORNER $X \le 3mm$ \ $Y \le 3mm$ \ $Z < t$ \ $Z <$	EL BODDED	D	>0.5mm	NOT ACCEPTABLE			
FDGF	CHIP ON GLASS	CORNER	$Y \le 3mm \cdot Z < t$		Chip	of glass	z z
		EDGE			Y	Xx	×X.



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13. INSPECTION CRITERION

13.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.($\rm E.D.T$) TO CUSTOMERS

13.2 INSPECTION CONDITIONS

13.2.1 (1)OBSERVATION DISTANCE: 35cm±5cm

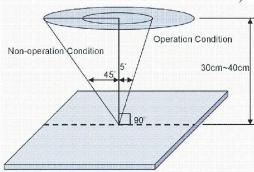
(2) VIEW ANGLE:

NON-OPERATION CONDITION: ±5°

(PERPENDICULAR TO LCD PANEL SURFACE)

OPERATION CONDITION: ±45°

(PERPENDICULAR TO LCD PANEL SURFACE)



13.2.2 ENVIRONMENT CONDITIONS:

AMBIEN'	20°C~25°C	
AMBIE	65±20%RH	
AMBIENT ILLUMINATION	COSMETIC INSPECTION	MORE THAN 600Lux
	FUNCTIONAL	300~500 Lux
	INSPECTION	300~300 Lux

13.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

13.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY (a)APPLICABLE STANDARD:

MIL-STD-105E

NORMAL INSPECTION, SINGLE SAMPLING

Level Π

(b)AQL : Major defect : AQL 0.65 Minor defect : AQL 1.0



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13.3 INSPECTION STANDARDS

13.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	
MAJOR DEFECT	2.BACKLIGHT	NO LIGHT FLICKERING AND OTHER ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	 BLACK/WHITE SPOT BUBBLES ON POLARIZER NEWTON RING BLACK/WHITE LINE SCRATCH CONTAMINATION LEVER COLOR SPREED 	
MINOR DEFECT	2.BEZEL ZONE	• STAINS • SCRATCHES • FOREIGN MATTER	1.0
	3.SOLDERING 4.DISPLAY ON	 INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS LIGHT LINE 	
	(ALL ON)	CIGHT LINE	



	13.3.2 MODULE	DEFECTS CF	ALSSIFICATION			
NO.	ITEM		100-1	ITERIA		
1.	DISPLAY ON INSPECTION	(1)INCORREC' (2)MISSING SE (3)DIM SEGME (4)OPERATING	EGMENT	ND SPEC		
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC				
		(1) INSPECTION AND BLUE (2)	N PATTERN: FULL 'SCREENS. ITEMS	WHITE, FULL BLA		REEN
		BRIGHT DO	Direct Collection Color Structure	N ≤ 2		
		DARK DOT		$N \leq 3$		
		TOAL BRIG	HT AND DARK DOT	S $N \le 4$		
		PANEL IS DI 3. DARK DOT :	AR BRIGHT AND UN SPLAYING UNDER	BLACK PATTERN		
			SPLAYING UNDER			
	EODEIGN		SPLAYING UNDER WIDTH: W		N, BLUE PIC	
	FOREIGN BLACK/WHITE/	PANEL IS DI		PURE RED, GREET	N, BLUE PIC	
4.	BLACK/WHITE/ BRIGHT LINE/	PANEL IS DI LENGTH: L	WIDTH: W	PURE RED, GREEN PERMISSIBLE NO	N, BLUE PIC	
4.	BLACK/WHITE/ BRIGHT LINE/ SCRATCH	PANEL IS DI LENGTH: L L \le 0.3	WIDTH: W W≤0.05	PURE RED, GREET PERMISSIBLE NO IGNORE	N, BLUE PIC	
4.	BLACK/WHITE/ BRIGHT LINE/	PANEL IS DI LENGTH: L ≤ 0.3 $0.3 < L \leq 2.5$ $2.5 < L$ WIDTH: W mi	$\begin{tabular}{ll} WIDTH: W & $W \le 0.05$ \\ \hline $0.05 < W \le 0.1$ \\ \hline $0.1 < W$ \\ \hline $m, LENGH: Lmm$ \\ \end{tabular}$	PURE RED, GREEI PERMISSIBLE NO IGNORE 4 NONE	N, BLUE PIC	TURE.
4.	BLACK/WHITE/ BRIGHT LINE/ SCRATCH	PANEL IS DI $L = 0.3$ $0.3 < L \le 2.5$ $2.5 < L$ WIDTH: W m $AVERAGE D$	$WIDTH: W$ $W \le 0.05$ $0.05 < W \le 0.1$ $0.1 < W$ $m, LENGH: L mm$ $0IAMETER (mm): D$	PURE RED, GREET PERMISSIBLE NO IGNORE 4 NONE	N, BLUE PIC O. CES PERMIT	TURE.
4.	BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	PANEL IS DI $L = 0.3$ $0.3 < L \le 2.5$ $2.5 < L$ WIDTH: W m $AVERAGE D$	$WIDTH: W \\ W \le 0.05 \\ 0.05 < W \le 0.1 \\ 0.1 < W \\ m, LENGH: L mm \\ DAMETER (mm): D \\ 0 \le 0.15$	PURE RED, GREET PERMISSIBLE NO IGNORE 4 NONE NUMBER OF PIE IGN	N, BLUE PIC O. CES PERMIT	TURE.
4.	BLACK/WHITE/ BRIGHT LINE/ SCRATCH	PANEL IS DI $L = 0.3$ $0.3 < L \le 2.5$ $2.5 < L$ WIDTH: W m $AVERAGE D$ 0.15	$WIDTH: W$ $W \le 0.05$ $0.05 < W \le 0.1$ $0.1 < W$ $m, LENGH: L mm$ $0IAMETER (mm): D$	PURE RED, GREET PERMISSIBLE NO IGNORE 4 NONE NUMBER OF PIE IGN	N, BLUE PIC D. CES PERMITORE 4	TURE.



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	ITEM		CRITERIA	
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED
			D ≤ 0.25	IGNORE
		BUBBLE ON THE	$0.25 \le 0.23$ $0.25 \le D \le 0.5$	N≤5
		POLARIZER	0.23 < D ≤ 0.3 0.5 < D	NOTE
			D < 0.1 mm	IGNORE
		SURFACE STATUS	$0.1 < D \le 0.3$ mm	N ≤ 3
			D < 0.1 mm	IGNORE
		CF FAIL / SPOT	$0.1 < D \le 0.3$ mm	N ≤ 3
	BUBBLES OF	NOTE (1)DOLADIZ	ER BUBBLE IS DEFINED	The state of the s
6.	POLARIZER /DIRT/CF FAIL /SURFACE STAINS	BUBBLE APPEARS (2)THE EXT OBSERV (3)THE DEF AS FOLL	VE DISPLAY AREA. THE ISHALL BE IGNORED IF TENDE OF ACTION OF ACTION OF ACTION OF ACTION OF AVERAGE DOWNING. BE DIAMETER (D)=(a+b)/2	HE POLARIZER BUBBLE CTIVE DISPLAY AREA. S DEFINED AS IT CAN B IS POWER ON.
7.	LINE DEFECT ON DISPLAY	**	L OR HORIZONTAL LINE	DEFECT IS NOT ALLOW
8.	MURA ON DISPLAY	IT'S OK IF MURA IS	SLIGHT VISIBLE THROU	NG 6% ND FILTER
9.	UNEVEN COLOR SPREAD, COLORATION		IED BASED UPON THE ST	
10.	BEZEL APPEARANCE	PRINTS STAINS C	HAVE RUST, BE DEFORM OF OTHER CONTAMINATI MPLY WITH JOB SPECIFIC	ON.
11	PCB	THE SEAL AREA (THAN THREE PLA (2)NO OXIDATION COMPARTS ON PCB MCHARACTERISTIC THERE SHOULD EPARTS. (4)THE JUMPER ON CHARACTERISTIC	OR CONTAMINATION PCF UST BE THE SAME AS OF CCHART. BE NO WRONG PARTS, M THE PCB SHOULD CONF	E SHOULD BE NO MORE B TERMINALS. N THE PRODUCTION SSING PARTS OR EXCE



NO. ITEM CRITERIA (I)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (3)IS,I, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD (b)CHIP COMPONENT SOLDER FILLET (b)CHIP COMPONENT SOLDER FILLET (c) SOLDER FILLET (d) SOLDER FILLET (e) SOLDER FILLET (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (g) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SURFACE AREA AREA COVERED	NO. ITEM (1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)NSUFFICENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 SOLDER FILLET 1/2 SOLDER FILLET (3)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC	EMER	GING	DISPLAY	MODEL NO.	VERSION	PAGE
(3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (2)INSUFFICENT SOLDER (3)INSUFFICENT SOLDER IS BETWEEN LOWER BEND OR (a)LSI, IC (b)CHIP COMPONENT (b)CHIP COMPONENT (c)LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT (c)LEAD AND FRONT FACE (d)LSI, IC (d)LSI, IC (d)LSI, IC	(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 SOLDER FILLET 1/2 SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (3)PARTS ALIGMENT (a)LSI, IC	TECHN	NOLOGIES	CORPORATION	ET057090DHU	2	24
(3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (2)INSUFFICENT SOLDER (3)INSUFFICENT SOLDER IS BETWEEN LOWER BEND OR (a)LSI, IC (b)CHIP COMPONENT (b)CHIP COMPONENT (c)LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT (c)LEAD AND FRONT FACE (d)LSI, IC (d)LSI, IC (d)LSI, IC	(3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (a)LSI, IC (3)PARTS ALIGMENT (2)INSUFFICENT SOLDER (3)INSUFFICENT SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT • SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET (c) SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED (3)PARTS ALIGMENT (a)LSI, IC			T			
		NO.	ITEM	(1)NO SOLDER: (2)INSUFFICEN (a)LSI, IC A POOR W "HEEL" OF (b)CHIP CON SOLDER WETTIN • SOLDER WE SIDES AND I	CRITERIA ING FOUND ON THE SPECIFIED PLA IT SOLDER VETTING OF SOLDER IS BETWEEN L F LEAD AND PAD SOLDER FILLET MPONENT R IS LESS THAN 50% OF SIDES AND I SOLDER FILLET 1/2 STS 3 SIDES OF TERMINAL, BUT LES FRONT SURFACE AREA ARE COVER SOLDER SOL	CE OWER BENI FRONT FACI S THAN 25% ED R	O OR



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NO.	ITEM	CRITERIA			
12.	SOLDERING	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE			
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.			
13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGEL USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.			
14.	GENERAL APPEARANCE	 (1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK. 			



DISPLAY S CORPORATION	MODEL NO			VERSION 2	P
	LIUJ	707011		4	
r		CRITERIA			
		a sty2 ty2>, s 2t *W=DISTANCE SEALANT PANEL ED X = LCD SIDE	b < VIEWING A ≤ W/2 E BETWEE AREA AN OGE E LENGTH	AREA S	c ≤ 1/8X ≤ 1/8X
ASS	b	SEALANT PANEL ED X = LCD SIDE $t = GLASS TE$ $\begin{array}{c} a \\ \leq t \\ \end{array}$ * X=LCD SIDE	≤W/2 BETWEE AREA AN GE BLENGTH HICKNESS b ≤0.5mm WIDTH	EN D LCD	c ≤ 1/8X ≤ 1/8X
		a b c \$\leq t\$ \leq 1/8\times\$ \leq 1 *X=LCD SIDE WIDTH \$t = GLASS THICKNESS \$L=ELECTRODE PAD LENGTH OIF GLASS CHIPPING THE ITO TERMINAL, OVER 2/3 OF THE ITO M REMAIN AND BE, INSPECTED ACCORDING TO ELECTRODE TERMINAL SPECIFICATIONS OIF THE PRODUCT WILL BE HEAT SEALED BY THE CUSTOMER, THE ALIGNMENT MARK MUST NOT BE DEMAGED			
	THE LCD WIT GENERAL GL	THE LCD WITH EXTENSIVE OF GENERAL GLASS CHIP: W C C C C C C C C C C C C C C C C C C	THE LCD WITH EXTENSIVE CRACK IS NOT GENERAL GLASS CHIP: a	ASS CORNER PART: CORNER PART	THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE GENERAL GLASS CHIP:



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13.4 RELIABILITY TEST

13.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +60°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -10°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
4	IEMPERATURE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
5	HIGH TEMP / HUMIDIT Y TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -40°C FOR 30 MINUTES ~ +80°C FOR 30 MINUTES
7	ESD (ELECTROSTATIC DISCHARGE)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.



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13.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 13.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

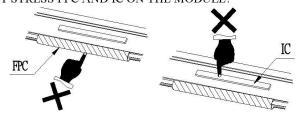
NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	IRREER TO SPECIFIC ATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

13.6 OPERATION

- 13.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 13.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 13.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 13.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.

 IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 13.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

 DO NOT STRESS FPC AND IC ON THE MODULE!





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13.7 NOTICE

- 13.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 13.7.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 13.7.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNAL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 13.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 13.7.5 DON'T GIVE EXTERNAL SHOCK.
- 13.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 13.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.

 WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 13.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 13.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 13.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 13.7.11 REWIRING: NO MORE THAN 3 TIMES.



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